

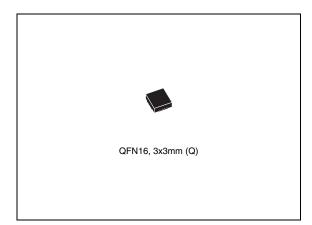
# STM1404

3V FIPS-140

## Security supervisor with battery switchover

#### **Features**

- STM1404 supports FIPS-140 security level 4
  - Four high-impedance physical tamper inputs
  - Over/Under operating voltage detector
  - Security alarm (SAL) on tamper detection
  - Over/Under operating temperature detector
  - Over/Under temperature thresholds are customer-selectable and factoryprogrammed
- Supervisory functions
  - Automatic battery switchover
  - RST output (open drain)
  - Manual (push-button) reset input (MR)
  - Power-fail comparator (PFI/PFO)
- Vccsw (V<sub>CC</sub> switch output)
  - Low when switched to V<sub>CC</sub>
  - High when switched to V<sub>BAT</sub> (BATT ON indicator)
- Battery low voltage detector (power-up)



- Optional V<sub>REF</sub> (1.237V)
  - (Available for STM1404A only)
- Low battery supply current (5.3µA Typ)
- Secure low profile 16-pin, 3x3mm, QFN package
- RoHS compliance
  - Lead-free components compliant with the RoHS directive

Table 1. Device options

	Supervisory functions <sup>(1)</sup>	Physical tamper inputs	Over/under voltage alarms	Over/under temperature alarms	V <sub>REF</sub> (1.237V) option	V <sub>OUT</sub> status, during alarm	Vccsw status, during alarm
STM1404A	~	~	V	V	~	ON	Normal mode <sup>(2)</sup>
STM1404B <sup>(3)</sup>	~	~	~	<b>V</b>	Note <sup>(4)</sup>	High-Z	High
STM1404C	<b>V</b>	~	<b>V</b>	<b>V</b>	Note <sup>(4)</sup>	Ground	High

- 1.  $\overline{SAL}$ ,  $\overline{RST}$ ,  $\overline{PFO}$ , and  $\overline{BLD}$  are open drain.
- 2. Normal mode: low when V<sub>OUT</sub> is internally switched to V<sub>CC</sub> and high when V<sub>OUT</sub> is internally switched to battery.
- 3. Contact local ST sales office for availability.
- 4. Pin 9 is the  $V_{REF}$  pin for STM1404A. It is the  $V_{TPU}$  pin for STM1404B/C.

February 2007 Rev 4 1/36

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## **Summary description**

The STM1404 family of security supervisors are a low power family of intrusion (tamper) detection chips targeted at manufacturers of POS terminals and other systems, to enable them to meet **physical and/or environmental** intrusion monitoring requirements as mandated by various standards, such as Federal Information Processing Standards (FIPS) Pub 140 entitled "Security Requirements for Cryptographic Modules," published by the National Institute of Standards and Technology, U.S. Department of Commerce), EMVCo, ISO, ZKA, and VISA PED.

STM1404 will target the highest security level 4 and include both physical and environmental (voltage and temperature) monitoring.

The STM1404 include Automatic Battery Switchover, RST Output (Open Drain), Manual (Push-button) Reset Input (MR), Power-fail Comparator (PFI/PFO), Physical and/or Environmental Tamper Detect/Security Alarm, and Battery Low Voltage Detect features.

The STM1404A also offers a  $V_{REF}$  (1.237V) as an option on pin 9. On STM1404B/C this pin is  $V_{TPU}$  (internally switched  $V_{CC}$  or  $V_{BAT}$ ).

## **V<sub>OUT</sub>** pin modes

The STM1404 is available in three versions, corresponding to three modes of the  $V_{OUT}$  pin (Supply Voltage Out), when the  $\overline{SAL}$  (Security Alarm) is asserted (active-low) upon tamper detection:

#### STM1404A

 $V_{OUT}$  stays ON (at  $V_{CC}$  or  $V_{BAT}$ ) when  $\overline{SAL}$  is driven low (activated).

#### STM1404B

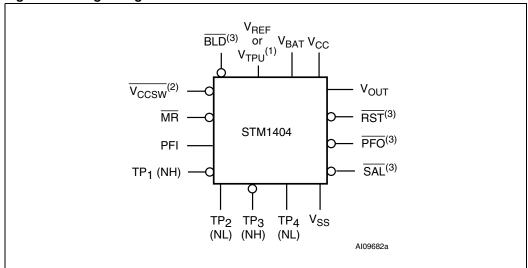
V<sub>OUT</sub> is set to High-Z when SAL is driven low (activated).

#### STM1404C

 $V_{OUT}$  is driven to Ground when  $\overline{SAL}$  is activated (may be used when  $V_{OUT}$  is connected directly to the  $V_{CC}$  pin of the external SRAM that holds the cryptographic codes).

All variants (see *Table 1: Device options*) are pin-compatible and available in a security-friendly, low profile, 16-pin QFN package.

Figure 1. Logic diagram



- 1.  $V_{REF}$  only for STM1404A;  $V_{TPU}$  for STM1404B/C.
- Normal Mode: Low when V<sub>OUT</sub> is internally switched to V<sub>CC</sub> and High when V<sub>OUT</sub> is internally switched to battery.
- 3.  $\overline{SAL}$ ,  $\overline{RST}$ ,  $\overline{PFO}$ , and  $\overline{BLD}$  are open drain.

Table 2. Signal names

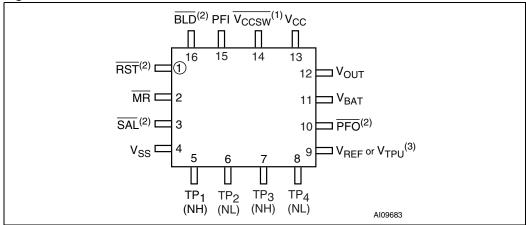
Vccsw <sup>(1)</sup>	V <sub>CC</sub> Switch output
MR	Manual (push-button) reset input
PFI	Power-fail input
TP <sub>1</sub> - TP <sub>4</sub>	Independent physical tamper detect pins 1 through 4
V <sub>OUT</sub>	Supply voltage output
RST <sup>(2)</sup>	Active-low reset output
PFO <sup>(2)</sup>	Power-fail output
SAL <sup>(2)</sup>	Security alarm output
BLD <sup>(2)</sup>	Battery low voltage detect
V <sub>REF</sub> <sup>(3)</sup>	1.237V Reference voltage
V <sub>TPU</sub> <sup>(3)</sup>	Tamper pull-up
11.0	(V <sub>CC</sub> or V <sub>BAT</sub> )
$V_{BAT}$	Back-up supply voltage
V <sub>CC</sub>	Supply voltage
V <sub>SS</sub>	Ground

- Normal mode: low when V<sub>OUT</sub> is internally switched to V<sub>CC</sub> and high when V<sub>OUT</sub> is internally switched to battery.
- 2. SAL, RST, PFO, and BLD are open drain.
- 3.  $V_{REF}$  only for STM1404A;  $V_{TPU}$  for STM1404B/C.

Note: See Section : Pin descriptions on page 12 for details.



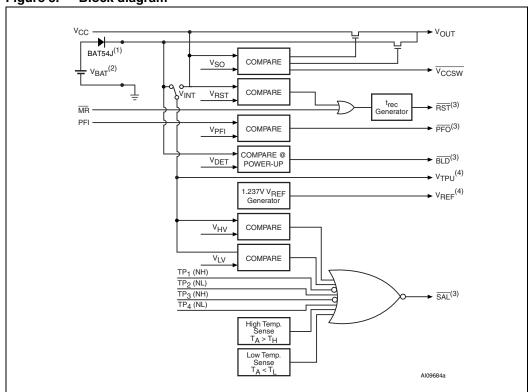
Figure 2. QFN16 connections



Note: See Section: Pin descriptions on page 12 for details.

- Normal mode: low when V<sub>OUT</sub> is internally switched to V<sub>CC</sub> and high when V<sub>OUT</sub> is internally switched to battery.
- 2. SAL, RST, PFO, and BLD are open drain.
- 3.  $V_{REF}$  only for STM1404A;  $V_{TPU}$  for STM1404B/C.

Figure 3. Block diagram



- 1. Required for battery-reverse charging protection.
- 2. User supplied.
- 3. Open drain.
- 4.  $V_{REF}$  only for STM1404A;  $V_{TPU}$  for STM1404B/C.

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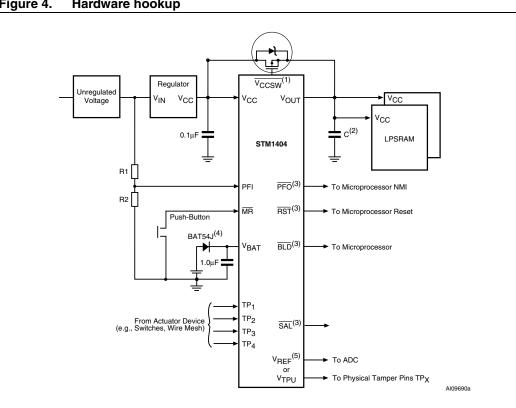
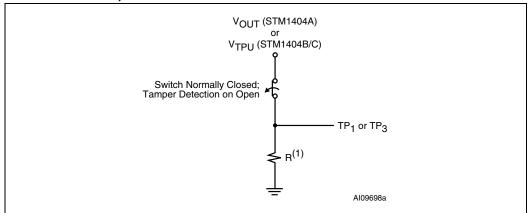


Figure 4. Hardware hookup

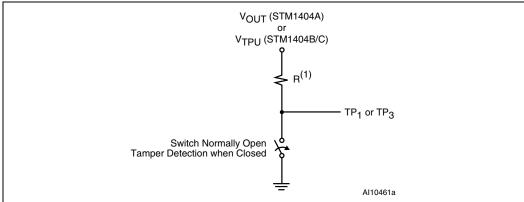
- Normal mode: low when  $V_{OUT}$  is internally switched to  $V_{CC}$  and high when  $V_{OUT}$  is internally switched to
- 2. Capacitor (C) is typically  $\geq 10 \mu F$ .
- 3. Open drain
- 4. Diode is required for battery reverse charge protection.
- 5.  $V_{REF}$  only for STM1404A;  $V_{TPU}$  for STM1404B/C.

Figure 5. Tamper Pin (TP<sub>1</sub> or TP<sub>3</sub>) Normally High (NH) external hookup (switch closed)



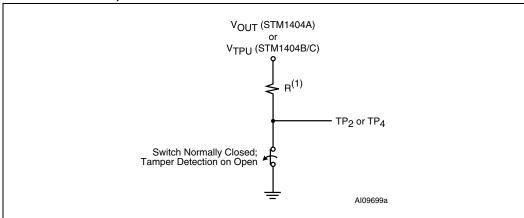
1. R typical is  $10M\Omega$ . Resistors must be protected against conductive materials.

Figure 6. Tamper Pin (TP<sub>1</sub> or TP<sub>3</sub>) Normally High (NH) external hookup (switch open)



1. R typical is  $10M\Omega$ . Resistors must be protected against conductive materials.

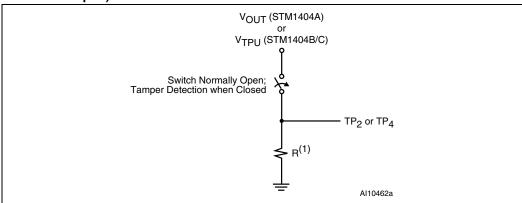
Figure 7. Tamper Pin (TP<sub>2</sub> or TP<sub>4</sub>) Normally Low (NL) external hookup (switch closed)



1. R typical is  $10M\Omega$ . Resistors must be protected against conductive materials.

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Figure 8. Tamper Pin (TP<sub>2</sub> or TP<sub>4</sub>) Normally Low (NL) external hookup (switch open)



1. R typical is  $10M\Omega$ . Resistors must be protected against conductive materials.

Pin descriptions STM1404

## Pin descriptions

See Figure 1: Logic diagram and Table 2: Signal names for a brief overview of the signals connected to this device.

## SAL, Security alarm output (open drain)

This signal can be generated when ANY of the following conditions occur:

- V<sub>INT</sub> > V<sub>HV</sub>, where V<sub>HV</sub> = upper voltage trip limit (4.2V typ); and where V<sub>INT</sub> = V<sub>CC</sub> or V<sub>RAT</sub>;
- V<sub>INT</sub> < V<sub>LV</sub>, where V<sub>LV</sub> = lower voltage trip limit (2.0V typ); and where V<sub>INT</sub> = V<sub>CC</sub> or V<sub>RAT</sub>; or
- When any of the physical tamper inputs, TP<sub>1</sub> to TP<sub>4</sub>, change from their normal states to the opposite (i.e., intrusion of a physical enclosure).
- T<sub>A</sub> > T<sub>H</sub>, where T<sub>H</sub> is an upper temperature trip limit specified by the customer (+80°C, +85°C, and +95°C), factory-programmed (STM1404 only);
- $T_A < T_L$ , where  $T_L$  is a lower temperature trip limit specified by the customer (–25°C or
- −35°C), factory-programmed (STM1404 only);

Note: 1 The default state of the SAL output during initial power-up is undetermined.

2 The alarm function will operate either with  $V_{CC}$  on or when the part is internally switched from  $V_{CC}$  to  $V_{BAT}$ .

#### TP<sub>1</sub>, TP<sub>3</sub>

Physical Tamper Detect Pin set normally to High (NH). They are connected externally through a closed switch or a high-impedance resistor to  $V_{OUT}$  (in the case of STM1404A) or  $V_{TPU}$  (in the case of STM1404B/C. A tamper condition will be detected when the input pin is pulled low (see *Figure 5* and *Figure 6 on page 10*). If not used, tie the pin to  $V_{OUT}$  (for STM1404A) or  $V_{TPU}$  (for STM1404B/C).

#### $TP_2, TP_4$

Physical Tamper Detect Pin set normally to Low (NL). They are connected externally through a high-impedance resistor or a closed switch to  $V_{SS}$ . A tamper condition will be detected when the input pin is pulled high (see *Figure 7* and *Figure 8 on page 11*). If not used, tie the pin to  $V_{SS}$ .

## Vccsw, V<sub>CC</sub> switch output

This output is low when  $V_{OUT}$  (see *Section : V\_{OUT} on page 14*) is internally switched to  $V_{CC}$ ; in this mode it may be used to turn on an external p-channel MOSFET switch which can source an external device directly from  $V_{CC}$  for currents greater than 80mA (bypassing the STM1404).

This pin goes high when  $V_{OUT}$  is internally switched to  $V_{BAT}$  and may be used as a "BATTERY ON" indicator.

STM1404 Pin descriptions

If a Security Alarm (SAL) is issued on Tamper, then the state of the Vccsw pin is as follows:

- STM1404A (V<sub>OUT</sub> remains ON when SAL is active-low): Vccsw pin will continue to operate in normal mode;
- 2. STM1404B (V<sub>OUT</sub> is taken to High-Z when SAL is active-low): Vccsw pin will be set to High when this occurs; and
- STM1404C (V<sub>OUT</sub> is driven to Ground when SAL is active-low): Vccsw pin will be set to High when this occurs.

### BLD, V<sub>BAT</sub> low voltage detect output (open drain)

This is an internally loaded test of the battery, activated only during a power-up sequence to insure that the battery is good either prior to or after encapsulation of the module. There are three customer options for  $V_{\text{DFT}}$ :

- 2.3V (2.5V external diode drop of about 0.2V) for a 3V lithium cell;
- 2.5V (2.7V 0.2V) for a 3V lithium cell; or
- 3.2V (3.4V 0.2V) for a 3.68V lithium "AA" battery.

This output pin will go active-low when it detects a voltage on the  $V_{BAT}$  pin below  $V_{DET}$ . BLD will be released when  $V_{CC}$  drops below  $V_{RST}$ .

## Active-low RST output (open drain)

Goes low and stays  $\underline{low}$  when  $V_{CC}$  drops below  $V_{RST}$  (Reset Threshold selected by the customer), or when  $\overline{MR}$  is logic low. It remains low for  $t_{rec}$  (200ms, typical) AFTER  $V_{CC}$  rises above  $V_{RST}$  and  $\overline{MR}$  goes from low to high.

## MR, Manual reset input

A logic low on  $\overline{\text{MR}}$  asserts the  $\overline{\text{RST}}$  output. The  $\overline{\text{RST}}$  output remains asserted as long as  $\overline{\text{MR}}$  is low and for  $t_{\text{rec}}$  after  $\overline{\text{MR}}$  returns to high. This active low input has an internal  $40\text{k}\Omega$  (typical) pull-up resistor. It can be driven from a TTL or CMOS Logic line or shorted to Ground with a switch. Leave it open if unused.

## PFO, Power-fail output (open drain)

When PFI is less than  $V_{PFI}$  (Power-fail Input Threshold Voltage) or  $V_{CC}$  falls below  $V_{SW}$  (battery switchover threshold ~ 2.4V),  $\overline{PFO}$  goes low, otherwise,  $\overline{PFO}$  remains high. Leave this pin open if unused.

#### PFI, Power-fail input

When PFI is less than  $V_{PFI}$ , or when  $V_{CC}$  falls below  $V_{SW}$  (see  $\overline{PFO}$ , above),  $\overline{PFO}$  goes active-low. If this function is unused, connect this pin to  $V_{SS}$ .

### V<sub>REF</sub>, Reference voltage output (1.237, typ)

This is valid only when  $V_{CC}$  is between 2.4V and 3.6V. When  $V_{CC}$  falls below 2.4V  $(V_{SW})$ ,  $V_{REF}$  is pulled to Ground with an internal  $100 \mathrm{k}\Omega$  resistor. This is an optional feature available on the STM1404A. On the STM1404B/C, this pin is  $V_{TPU}$  (internally switched  $V_{CC}$  or  $V_{BAT}$ ). If unused, this pin should float.



Pin descriptions STM1404

## $V_{OUT}$

This is the Supply Voltage Output. When  $V_{CC}$  rises above  $V_{SO}$  (Battery Backup Switchover Voltage),  $V_{OUT}$  is supplied from  $V_{CC}$ . In this condition,  $V_{OUT}$  may be connected externally to  $V_{CC}$  through a p-channel MOSFET switch. When  $V_{CC}$  falls below the lower value of  $V_{SW}$  (~2.4V), or  $V_{BAT}$ ,  $V_{OUT}$  is supplied from  $V_{BAT}$ . It is recommended that the  $V_{OUT}$  pin be connected externally to a capacitor that will retain a charge for a period of time, in case an intruder forces  $V_{CC}$  or  $V_{BAT}$  to Ground. The rectifying diode connected from the positive terminal of the battery to the  $V_{BAT}$  pin of the STM1404 will prevent discharge of the capacitor.

Three variations of parts will be offered with the following options:

- STM1404A: V<sub>OUT</sub> remains ON when SAL is active-low; Vccsw pin will continue to operate in normal mode (see Section: Vccsw, V<sub>CC</sub> switch output on page 12);
- 2. STM1404B: V<sub>OUT</sub> is taken to High-Z when SAL is active-low; Vccsw pin will be set to High when this occurs; and
- 3. STM1404C: V<sub>OUT</sub> is driven to Ground when SAL is active-low; Vccsw pin will be set to High when this occurs.

#### **V<sub>TPU</sub>**

For STM1404B and STM1404C, this pin provides pull-up voltage for the physical tamper pins (TP1-4). This pin is not to be used as voltage supply source for any other purpose.

Note:  $V_{TPU}$  is the internally switched supply voltage from either the  $V_{CC}$  pin or the  $V_{BAT}$  pin.

#### $V_{CC}$

This is the Supply voltage (2.2V to 3.6V).

## $V_{BAT}$

This is the secondary (backup battery) supply voltage. The pin is connected to the positive terminal of the battery with a rectifying diode like the BAT54J from STMicroelectronics for reverse charge protection. Voltage at this pin, after diode rectification, will be approximately 0.2V less than the battery voltage, and will depend on the type of battery used as well as the  $I_{BAT}$  being drawn. (A capacitor of at least 1.0µF connected between the  $V_{BAT}$  pin and  $V_{SS}$  is required.) If no battery is used, connect the  $V_{BAT}$  pin to the  $V_{CC}$  pin.

## $V_{SS}$

Ground, V<sub>SS</sub>, is the reference for the power supply. It must be connected to system ground.

STM1404 Operation

## **Operation**

### Reset input

The STM1404 Security Supervisor asserts a reset signal to the MCU whenever  $V_{CC}$  goes below the reset threshold ( $V_{RST}$ ), or when the Push-button Reset Input ( $\overline{MR}$ ) is taken low.  $\overline{RST}$  is guaranteed to be a logic low for  $0V < V_{CC} < V_{RST}$  if  $V_{BAT}$  is greater than 1V. Without a back-up battery,  $\overline{RST}$  is guaranteed valid down to  $V_{CC} = 1V$ .

During power-up, once  $V_{CC}$  exceeds the reset threshold an internal timer keeps  $\overline{RST}$  low for the reset time-out period,  $t_{rec}$ . After this interval  $\overline{RST}$  returns high.

If  $V_{CC}$  drops below the reset threshold,  $\overline{RST}$  goes low. Each time  $\overline{RST}$  is asserted, it stays low for at least the reset time-out period ( $t_{rec}$ ). Any time  $V_{CC}$  goes below the reset threshold the internal timer clears. The reset timer starts when  $V_{CC}$  returns above the reset threshold.

## **Push-button reset input**

A logic low on  $\overline{MR}$  asserts reset. Reset remains asserted while  $\overline{MR}$  is low, and for  $t_{rec}$  (see Figure 25 on page 25) after it returns high. The  $\overline{MR}$  input has an internal 40k $\Omega$  pull-up resistor, allowing it to be left open if not used. This input can be driven with TTL/CMOS-logic levels or with open-drain/collector outputs. Connect a normally open momentary switch from  $\overline{MR}$  to Ground to create a manual reset function; external debounce circuitry is not required. If  $\overline{MR}$  is driven from long cables or the device is used in a noisy environment, connect a 0.1µF capacitor from  $\overline{MR}$  to  $V_{SS}$  to provide additional noise immunity.  $\overline{MR}$  may float, or be tied to  $V_{CC}$  when not used.

## **Back-up battery switchover**

In the event of a power failure, it may be necessary to preserve the contents of external SRAM through  $V_{OUT}$ . With a backup battery installed with voltage  $V_{BAT}$ , the devices automatically switch the SRAM to the back-up supply when  $V_{CC}$  falls.

Note: If back-up battery is not used, connect both  $V_{BAT}$  and  $V_{OUT}$  to  $V_{CC}$ .

This family of Security Supervisors does not always connect  $V_{BAT}$  to  $V_{OUT}$  when  $V_{BAT}$  is greater than  $V_{CC}$ .  $V_{BAT}$  connects to  $V_{OUT}$  (through a  $100\Omega$  switch) when  $V_{CC}$  is below  $V_{SW}$  (~2.4V) or  $V_{BAT}$  (whichever is lower). This is done to allow the back-up battery (e.g., a 3.6V battery) to have a higher voltage than  $V_{CC}$ .

Assuming that  $V_{BAT}$  > 2.0V, switchover at  $V_{SO}$  ensures that battery back-up mode is entered before  $V_{OUT}$  gets too close to the 2.0V minimum required to reliably retain data in most external SRAMs. When  $V_{CC}$  recovers, hysteresis is used to avoid oscillation around the  $V_{SO}$  point.  $V_{OUT}$  is connected to  $V_{CC}$  through a 3 $\Omega$  PMOS power switch.

The back-up battery may be removed while  $V_{CC}$  is valid, assuming  $V_{BAT}$  is adequately decoupled (0.1µF typ), without danger of triggering a reset.

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Note:

Operation STM1404

Table 3. I/O status in battery back-up

Pin	Status
V <sub>OUT</sub>	Connected to V <sub>BAT</sub> through internal switch
V <sub>CC</sub>	Disconnected from V <sub>OUT</sub>
PFI	Disabled
PFO	Logic low
MR	Disabled
RST	Logic low
V <sub>BAT</sub>	Connected to V <sub>OUT</sub>
Vccsw	Logic high
V <sub>REF</sub>	Pulled to V <sub>SS</sub> below 2.4V (V <sub>SW</sub> )
BLD	Logic high
V <sub>TPU</sub>	Connected to V <sub>BAT</sub> through an internal switch

The Power-fail Input (PFI) is compared to an internal reference voltage (independent from the  $V_{RST}$  comparator). If PFI is less than the power-fail threshold ( $V_{PFI}$ ), the Power-Fail Output (PFO) will go low. This function is intended for use as an undervoltage detector to signal a failing power supply. Typically PFI is connected through an external voltage divider (see *Figure 4 on page 9*) to either the unregulated DC input (if it is available) or the regulated output of the  $V_{CC}$  regulator. The voltage divider can be set up such that the voltage at PFI falls below  $V_{PFI}$  several milliseconds before the regulated  $V_{CC}$  input to the STM1404 or the microprocessor drops below the minimum operating voltage.

During battery back-up, the power-fail comparator is turned off and  $\overline{PFO}$  goes (or remains) low (see *Figure 9 on page 17*). This occurs after  $V_{CC}$  drops below  $V_{SW}$  (~2.4V). When power returns, the power-fail comparator is enabled and  $\overline{PFO}$  follows PFI. If the comparator is unused, PFI should be connected to  $V_{SS}$  and  $\overline{PFO}$  left unconnected.  $\overline{PFO}$  may be connected to  $\overline{MR}$  so that a low voltage on PFI will generate a reset output.

## **Applications information**

These Supervisor circuits are not short-circuit protected. Shorting  $V_{OUT}$  to ground - excluding power-up transients such as charging a decoupling capacitor - destroys the device. Decouple both  $V_{CC}$  and  $V_{BAT}$  pins to ground by placing  $0.1\mu F$  capacitors as close to the device as possible.

STM1404 Operation

V<sub>CC</sub>
V<sub>RST</sub>

V<sub>SW</sub> (2.4V)

PFO follows PFI

RST

Al08861a

Figure 9. Power-fail comparator waveform

## Negative-going V<sub>CC</sub> transients and undershoot

The STM1404 devices are relatively immune to negative-going  $V_{CC}$  transients (glitches). Figure 23 on page 23 was generated using a negative pulse applied to  $V_{CC}$ , starting at  $V_{RST}$  + 0.3V and ending below the reset threshold by the magnitude indicated (comparator overdrive). The graph indicates the maximum pulse width a negative  $V_{CC}$  transient can have without causing a reset pulse. As the magnitude of the transient increases (further below the threshold), the maximum allowable pulse width decreases. Any combination of duration and overdrive which lies under the curve will NOT generate a reset signal. Typically, a  $V_{CC}$  transient that goes 100mV below the reset threshold and lasts 40 $\mu$ s or less will not cause a reset pulse. A 0.1 $\mu$ F bypass capacitor mounted as close as possible to the  $V_{CC}$  pin provides additional transient immunity (see Figure 10).

In addition to transients that are caused by normal SRAM operation, power cycling can generate negative voltage spikes on  $V_{CC}$  that drive it to values below  $V_{SS}$  by as much as one volt. These negative spikes can cause data corruption in the SRAM while in battery backup mode. To protect from these voltage spikes, STMicroelectronics recommends connecting a schottky diode from  $V_{CC}$  to  $V_{SS}$  (cathode connected to  $V_{CC}$ , anode to  $V_{SS}$ ). Schottky diode 1N5817 is recommended for through hole and MBRS120T3 is recommended for surface mount.

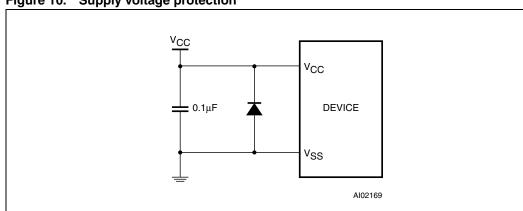


Figure 10. Supply voltage protection

Tamper detection STM1404

## **Tamper detection**

## **Physical**

There are four (4) high-impedance physical tamper detect input pins, 2 normally set to High (NH) and 2 normally set to Low (NL). Each input is designed with a glitch immunity (see *Table 7 on page 30*). These inputs can be connected externally to several types of actuator devices (e.g., switches, wire mesh). A tamper on any one of the four inputs that causes its state to change will trigger the security alarm (SAL) and drive it to active-low. Once the tamper condition no longer exists, the SAL will return to its normal High state.

 $TP_1$  and  $TP_3$  are set Normally to High (NH). They are connected externally through a closed switch or a high-impedance resistor to  $V_{OUT}$  (in the case of STM1404A or STM1404A) or  $V_{TPU}$  (in the case of STM1404B/C), A tamper condition will be detected when the input pin is pulled low (see *Figure 5* and *Figure 6 on page 10*). If not used, tie the pin to  $V_{OUT}$  or  $V_{TPU}$ .

 $TP_2$  and  $TP_4$  are set Normally to Low (NL). They are connected externally through a high-impedance resistor or a closed switch to  $V_{SS}$ . A tamper condition will be detected when the input pin is pulled high (see *Figure 7* and *Figure 8 on page 11*). If not used, tie the pin to  $V_{SS}$ .

## Supply voltage

The internally switched supply voltage,  $V_{INT}$  (either  $V_{CC}$  input or  $V_{BAT}$  input) is continuously monitored. If  $V_{INT}$  should exceed the over voltage trip point,  $V_{HV}$  (set at 4.2V, typical), or should go below the under voltage trip point,  $V_{LV}$  (set at 2.0v, typical).  $\overline{SAL}$  will be driven active-low. Once the tamper condition no longer exists, the  $\overline{SAL}$  pin will return to its normal High state.

## **Temperature**

The STM1404 has a built-in, bandgap-based sensor to monitor the temperature. If a preset (customer-selectable, factory-programmed) over-temperature trip point  $(T_H)$  or undertemperature trip point  $(T_H)$  is exceeded, the  $\overline{SAL}$  is asserted low.

When no tamper condition exists, SAL is normally High (see Section : Pin descriptions on page 12).

When a tamper is detected, the  $\overline{SAL}$  is activated (driven low), independent of the part type.  $V_{OUT}$  can be driven to one of three states, depending on which variant of STM1404 is being used (see *Table 1 on page 1*):

- ON;
- High-Z; or
- Ground (V<sub>SS</sub>).

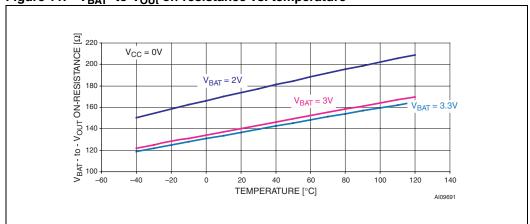
Note:

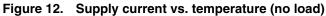
The STM1404 must be initially powered above  $V_{RST}$  to enable the tamper detection alarms. For example, if the battery is on while  $V_{CC}$  = 0V, no alarm condition can be detected until  $V_{CC}$  rises above  $V_{RST}$  (and  $t_{rec}$  expires). From this point on, alarms can be detected either on battery or  $V_{CC}$ . This is done to avoid false alarms when the device goes from no power to its operational state.

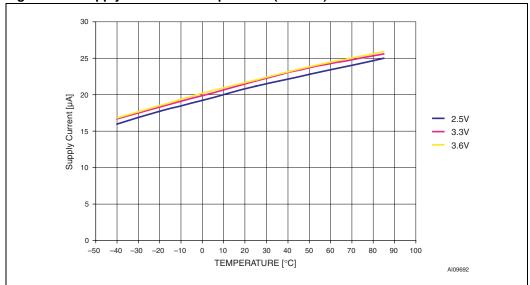
# **Typical operating characteristics**

Note: Typical values are at  $T_A = 25$ °C.

Figure 11. V<sub>BAT</sub> -to-V<sub>OUt</sub> on-resistance vs. temperature









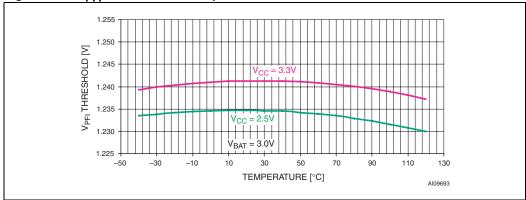


Figure 14. Reset comparator propagation delay vs. temperature

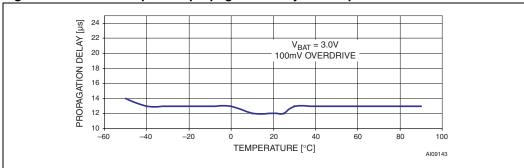


Figure 15. Power-up t<sub>rec</sub> vs. temperature

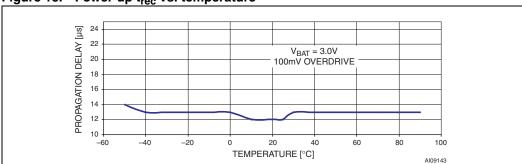
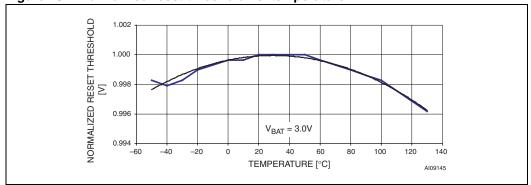


Figure 16. Normalized reset threshold vs. temperature



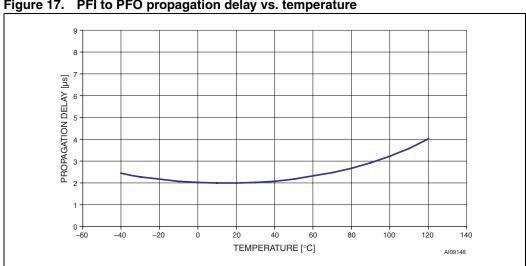
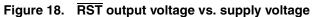
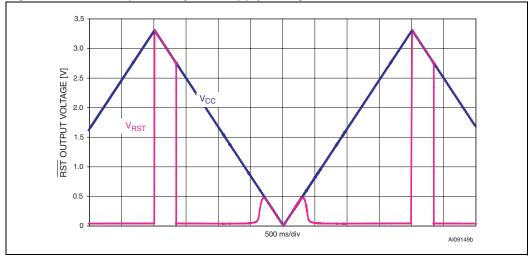


Figure 17.  $\overline{PFO}$  propagation delay vs. temperature









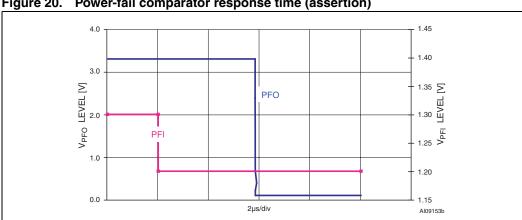
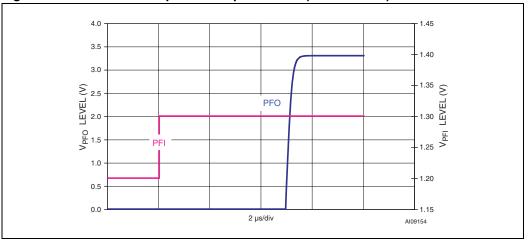


Figure 20. Power-fail comparator response time (assertion)





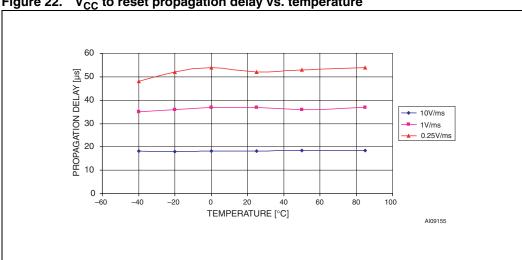
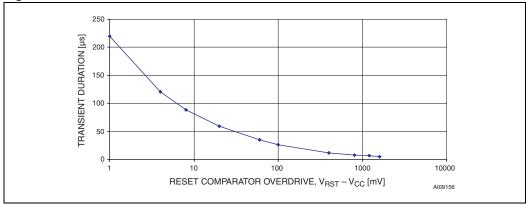


Figure 22. V<sub>CC</sub> to reset propagation delay vs. temperature





Maximum rating STM1404

## **Maximum rating**

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
T <sub>STG</sub>	Storage temperature (V <sub>CC</sub> Off, V <sub>BAT</sub> Off)	-55 to 150	°C
T <sub>SLD</sub> <sup>(1)</sup>	Lead solder temperature for 10 seconds	260	°C
V <sub>IO</sub>	Input or output voltage	-0.3 to V <sub>CC</sub> +0.3	V
V <sub>CC</sub> /V <sub>BAT</sub>	Supply voltage	-0.3 to 4.5	V
I <sub>O</sub>	Output current	20	mA
P <sub>D</sub>	Power dissipation	320	mW

Reflow at peak temperature of 255°C to 260°C for < 30 seconds (total thermal budget not to exceed 180°C for between 90 to 150 seconds).</li>

## **DC** and **AC** parameters

This section summarizes the operating measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics Tables that follow, are derived from tests performed under the Measurement Conditions summarized in *Table 5: Operating and AC measurement conditions*. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

Table 5. Operating and AC measurement conditions

Parameter	STM1404	Unit
V <sub>CC</sub> /V <sub>BAT</sub> supply voltage	2.2 to 3.6	V
Ambient operating temperature (T <sub>A</sub> )	-40 to 85	°C
Input rise and fall times	≤ 5	ns
Input pulse voltages	0.2 to 0.8V <sub>CC</sub>	V
Input and output timing ref. voltages	0.3 to 0.7V <sub>CC</sub>	V

Figure 24. AC testing input/output waveforms

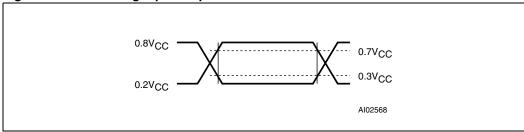


Figure 25. MR timing waveform

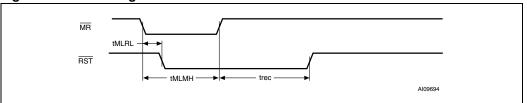


Figure 26. STM1404 switchover diagram, condition A ( $V_{BAT} < V_{SW}$ )

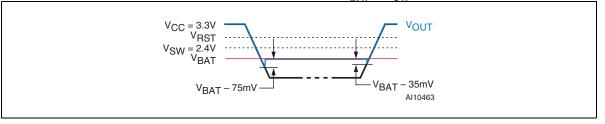


Figure 27. STM1404 switchover diagram, condition B ( $V_{BAT} > V_{SW}$ )

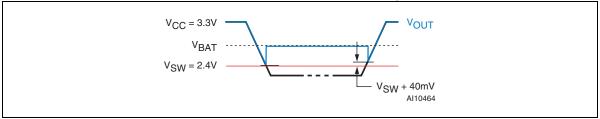


Table 6. DC and AC characteristics

Sym	Alter- native	Description	Test condition <sup>(1)</sup>	Min	Тур	Max	Unit
$V_{CC}$ , $V_{BAT}^{(2)}$		Operating voltage	$T_A = -40 \text{ to } +85^{\circ}\text{C}$	2.2		3.6	٧
		V <sub>CC</sub> supply current (STM1404A)	– Тур @ 3.3V, 25°С -		50	65	μΑ
I <sub>CC</sub>		V <sub>CC</sub> supply current (STM1404B,C)			35	50	μA
		V <sub>CC</sub> supply current in battery back-up mode	Excluding $I_{OUT}$ $(V_{BAT} = 2.3V, V_{CC} = 2.0V, \overline{MR} = V_{CC})$		25	35	μΑ
I <sub>BAT</sub> <sup>(3)</sup>		V <sub>BAT</sub> supply current in battery back-up mode	Excluding I <sub>OUT</sub> (V <sub>BAT</sub> = 3.6V)		5.3	8.0	μΑ
			$I_{OUT1} = 5mA^{(4)}$ $(V_{CC} > V_{SW})$	V <sub>CC</sub> - 0.03	V <sub>CC</sub> – 0.015		٧
V <sub>OUT1</sub>		V <sub>OUT</sub> voltage (active)	$I_{OUT}$ voltage (active) $I_{OUT1} = 80 \text{mA}$ $(V_{CC} > V_{SW})$	V <sub>CC</sub> - 0.3	V <sub>CC</sub> – 0.15		٧
		$I_{OUT1} = 250\mu A,$ $V_{CC} > V_{SW}^{(4)}$ $V_{C}$	V <sub>CC</sub> - 0.0015	V <sub>CC</sub> – 0.0006		٧	
V		V <sub>OUT</sub> voltage (battery	I <sub>OUT2</sub> = 250μA, V <sub>BAT</sub> = 2.2V	V <sub>BAT</sub> – 0.1	V <sub>BAT</sub> – 0.04		V
V <sub>OUT2</sub>		back-up) $I_{OUT2} = 1mA,$ $V_{BAT} = 2.2V$		V <sub>BAT</sub> – 0.16		٧	
V <sub>TPU1</sub>		Internal switched supply voltage (active)	$I_{SOURCE} = 5mA$ $(V_{CC} > V_{SW})$	V <sub>CC</sub> - 0.3			٧

Table 6. DC and AC characteristics (continued)

Sym	Alter- native	Description	Test condition <sup>(1)</sup>	Min	Тур	Max	Unit
V <sub>TPU2</sub>		Internal switched supply voltage (battery back-up)	I <sub>SOURCE</sub> = 1mA (V <sub>BAT</sub> = 2.2V)		V <sub>BAT</sub> – 0.10		٧
		Input leakage current (MR)	$\overline{MR} = 0V; V_{CC} = 3V$	20	75	350	μA
I <sub>LI</sub>		Input leakage current (PFI)	$0V = V_{IN} = V_{CC}$	-25	2	+25	nA
		Input leakage current (TP1-TP4)	$0V = V_{IN} = V_{CC}$	-1		+1	μA
I <sub>LO</sub>		Output leakage current	$0V = V_{IN} = V_{CC}^{(5)}$	-1		+1	μΑ
V <sub>IH</sub>		Input high voltage (MR)	V (max) + V + 2 6V	0.7V <sub>CC</sub>			V
V <sub>IL</sub>		Input low voltage (MR)	$V_{RST}$ (max) $< V_{CC} < 3.6V$			0.3V <sub>CC</sub>	V
V <sub>OL</sub>		Output low voltage (PFO, RST, Vccsw, SAL, BLD)	$V_{CC} = V_{RST}$ (max), $I_{SINK} = 3.2$ mA			0.3	V
V <sub>OL</sub>		Output low voltage (RST)	$I_{OL} = 40\mu A; V_{CC} = 1.0V;$ $V_{BAT} = V_{CC};$ $T_A = 0^{\circ}C \text{ to } 85^{\circ}C$ $I_{OL} = 200\mu A;$ $V_{CC} = 1.2V; V_{BAT} = V_{CC}$			0.3	V
		(1101)				0.3	٧

Table 6. DC and AC characteristics (continued)

Sym	Alter- native	Description	Test condition <sup>(1)</sup>		Min	Тур	Max	Unit
V <sub>OHB</sub>		V <sub>OH</sub> battery back-up (Vccsw)	I <sub>SOURCE</sub> = 100μA,		0.8V <sub>BAT</sub>			V
		Pull-up supply voltage (open drain)	RST, SAL	, BLD, PFO			3.6	V
Power-f	ail com	parator						
$V_{PFI}$		PFI input threshold	PFI falling (V <sub>CC</sub> < 3.6V)  PFI rising (V <sub>CC</sub> < 3.6V)		1.212	1.237	1.262	V
		PFI hysteresis				10	20	mV
t <sub>PFD</sub>		PFI to PFO propagation delay				2		μs
Battery	switcho	over						
			Power-	$V_{BAT} > V_{SW}$		V <sub>SW</sub>		V
		Battery back-up switchover voltage (6)(7)	down	V <sub>BAT</sub> < V <sub>SW</sub>		$V_{BAT}$		V
V	S		D	V <sub>BAT</sub> > V <sub>SW</sub>		V <sub>SW</sub>		V
$V_{SO}$			Power-up	V <sub>BAT</sub> < V <sub>SW</sub>		V <sub>BAT</sub>		V
		V <sub>SW</sub>				2.4		V
		Hysteresis				40		mV
Battery	low vol	tage detect		•			•	•
		Battery detect threshold		М	2.25	2.30	2.34	V
$V_{DET}$			On power- up only	N	2.45	2.50	2.55	V
			ар э <b>,</b>	0	3.14	3.20	3.26	V
Voltage	referen	ce (option for STM1404	<b>A)</b> <sup>(8)</sup>					•
		Voltage reference (see	0°C to 85°C		1.212	1.237	1.262	V
$V_{REF}$		Section : V <sub>REF</sub> Reference voltage output (1.237, typ) on page 13)	-40° to 0°C		1.200	1.237	1.274	V
	0		0°C to 85°C		15	25		μΑ
I <sub>REF+</sub>		Source current	–40° to 0°C		10	15		μΑ
I <sub>REF</sub>		Sink current			10	13		μΑ
V <sub>n</sub>		Output voltage noise	f = 100Hz to 100kH			10-100		μV <sub>rm</sub>

Table 6. DC and AC characteristics (continued)

		dia Ao onaraotoriot	( )	,					
Sym	Alter- native	Description	Test condition <sup>(1)</sup>		Min	Тур	Max	Unit	
Reset th	Reset thresholds								
V <sub>RST</sub> <sup>(9)</sup>	Reset thre		Т	V <sub>CC</sub> falling	3.00	3.075	3.15	V	
				V <sub>CC</sub> rising	3.00	3.085	3.17	V	
		Doost throohold	S	V <sub>CC</sub> falling	2.85	2.925	3.00	V	
		Heset threshold		V <sub>CC</sub> rising	2.85	2.935	3.02	V	
			R	V <sub>CC</sub> falling	2.55	2.625	2.70	V	
				V <sub>CC</sub> rising	2.55	2.635	2.72	V	
t <sub>rec</sub>		RST pulse width			140	200	280	ms	
Push-b	utton res	set input							
t <sub>MLMH</sub>	t <sub>MR</sub>	MR pulse width			100			ns	
t <sub>MLRL</sub>	t <sub>MRD</sub>	MR to RST output delay				60	500	ns	

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = -40$  to  $85^{\circ}C$ ;  $V_{CC} = V_{RST}$  (max) to 3.6V; and  $V_{BAT} = 2.8V$  (except where noted); typical values are for 3.3V and  $25^{\circ}C$ .

- 3. Tested at  $V_{BAT} = 3.6V$ , and  $V_{CC} = 0V$ .
- 4. Guaranteed by design.
- The leakage current measured on the RST, SAL, PFO, and BLD pins are tested with the output not asserted (output high impedance).
- 6. When  $V_{BAT} > V_{CC} > V_{SW}$ ,  $V_{OUT}$  remains connected to  $V_{CC}$  until  $V_{CC}$  drops below  $V_{SW}$ .
- 7. When  $V_{SW} > V_{CC} > V_{BAT}$ ,  $V_{OUT}$  remains connected to  $V_{CC}$  until  $V_{CC}$  drops below the battery voltage  $(V_{BAT}) 75 \text{mV}$ .
- 8. Maximum external capacitive load on  $V_{\mbox{\scriptsize REF}}$  pin cannot exceed 1nF.
- 9. The reset threshold tolerance is wider for V<sub>CC</sub> rising than for V<sub>CC</sub> falling due to the 10mV (typ) hysteresis, which prevents internal oscillation.

<sup>2.</sup>  $V_{CC}$  supply current, logic input leakage, push-button reset functionality, PFI functionality, state of  $\overline{RST}$  tested at  $V_{BAT} = 3.6V$ , and  $V_{CC} = 3.6V$ . The state of  $\overline{RST}$  and  $\overline{PFO}$  is tested at  $V_{CC} = V_{CC}$  (min).  $V_{BAT}$  is voltage measured at the pin.

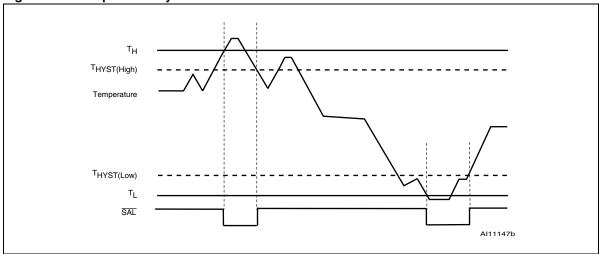
Table 7. Physical and environmental tamper detection levels

Sym	Parameter	Test conditions <sup>(1)</sup>	Min	Тур	Max	Unit
$V_{HV}$	Over voltage trip level		4.0	4.2	4.4	V
$V_{LV}$	Under voltage trip level		1.9	2.0	2.1	٧
	SAL propagation delay time (after over/under voltage detection)	V <sub>HV</sub> + 200mV or V <sub>LV</sub> – 200mV		25	40	μs
V <sub>HTP</sub>	Trip point for NH physical tamper input pins (TP <sub>1</sub> or TP <sub>3</sub> )		V <sub>OUT</sub> - 1.3 <sup>(2)</sup>		V <sub>OUT</sub> - 0.3 <sup>(2)</sup>	٧
$V_{LTP}$	Trip point for NL physical tamper input pins (TP <sub>2</sub> or TP <sub>4</sub> )		0.3		1.0	٧
	SAL propagation delay time <sup>(3)</sup> (after physical tamper pin detection)	$V_{HTP} = V_{OUT}/V_{TPU};$ $V_{LTP} = V_{SS}$ $V_{DD} = 3.6$		30	50	μs
	Physical tamper input (TP <sub>X</sub> ) glitch immunity			15		μs
T <sub>H</sub>	Factory-programmed	= 0mΛ	<b>-</b> 5	80, 85, 95	+5	°C
T <sub>L</sub>	i actory-programmed	$I_{OUT} = 0mA$	<b>-</b> 5	<b>−25</b> , <b>−35</b>	+5	°C
T <sub>HYST</sub>	Temperature hysteresis			10		°C

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = -40$  to  $85^{\circ}C$ ;  $V_{CC} = V_{LV}$  to  $V_{HV}$  (except where noted). All Physical and Environmental Tamper functions are operational across the full temperature alarm range for STM1404.

3.  $V_{CC} = V_{RST}$  (max) to 3.6V

Figure 28. Temperature hysteresis



<sup>2.</sup> In the case of STM1404A, Physical Tamper input pins (TP $_{\rm X}$ ) are referenced to V $_{\rm OUT}$  (Pin 12). In the case of STM1404B or C, TP $_{\rm X}$  are referenced to V $_{\rm TPU}$  pin (Pin 9).

# Package mechanical data

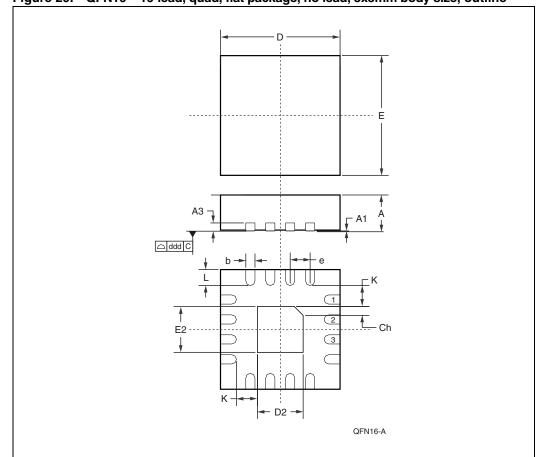


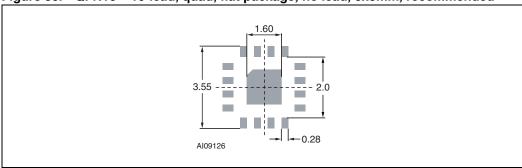
Figure 29. QFN16 – 16-lead, quad, flat package, no lead, 3x3mm body size, outline

Note: Drawing is not to scale.

Table 8. QFN16 – 16-lead, quad, flat package, no lead, 3x3mm body size mechanical data

Symb	mm			inches			
Syllib	Тур	Min	Max	Тур	Min	Max	
Α	0.90	0.80	1.00	0.035	0.032	0.039	
A1	0.02	0.00	0.05	0.001	0.000	0.002	
A3	0.20	_	_	0.008	_	_	
b	0.25	0.18	0.30	0.010	0.007	0.012	
D	3.00	2.90	3.10	0.118	0.114	0.122	
D2	1.70	1.55	1.80	0.067	0.061	0.071	
Е	3.00	2.90	3.10	0.118	0.114	0.122	
E2	1.70	1.55	1.80	0.067	0.061	0.071	
е	0.50	_	_	0.020	_	_	
К	0.20	_	_	0.008	_	_	
L	0.40	0.30	0.50	0.016	0.012	0.020	
ddd	_	0.08	_	_	0.003	_	
Ch	_	0.33	1	_	0.013	_	
N	16			16			

Figure 30. QFN16 – 16-lead, quad, flat package, no lead, 3x3mm, recommended

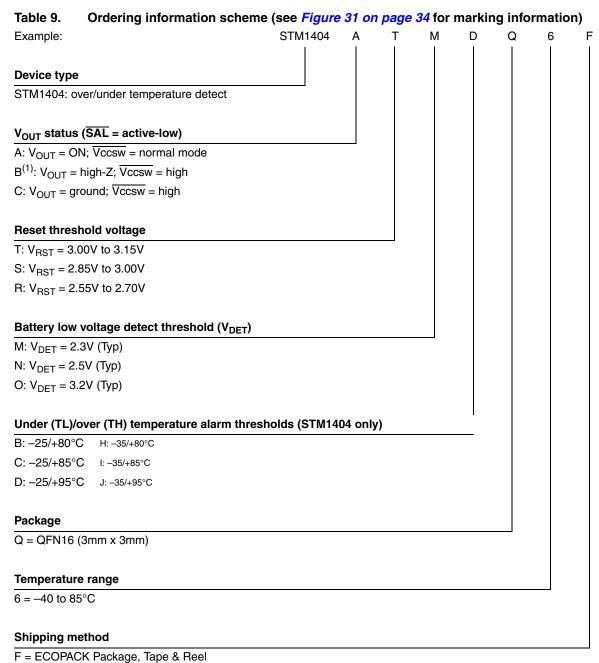


footprint

Note: Substrate pad should be tied to  $V_{SS}$ .

STM1404 Part numbering

## Part numbering



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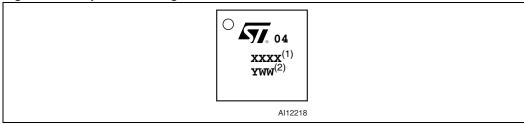
1. Contact local ST sales office for availability.

For other options, or for more information on any aspect of this device, please contact the ST sales office nearest you.

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Part numbering STM1404

Figure 31. Topside marking information



1. Options codes:

X = A, B, or C (for  $V_{OUT}$ )

X = T, S, or R (for Reset Threshold)

X = M, N, or O (for Battery Low Voltage Detect Threshold)

X = B, C, D, H, I, or J (for Temperature Alarm Threshold)

2. Traceability Codes

Y = Year

WW = Work Week

STM1404 Revision history

# **Revision history**

Table 10. Document revision history

Date	Version	Description
11-Oct-2004	1.0	First Edition
26-Nov-2004	1.1	Corrected footprint dimensions; update characteristics (Figure 1, 2, 3, 4, 5, 6, 7, 8, 26, 27, 30 and Table 1, 2, 3, 6, 7).
22-Dec-2004	1.2	Update characteristics (Figure 4, Tables 6, 7, 9).
03-Feb-2005	Teb-2005 1.3 Update characteristics ( <i>Figure 4</i> , Tables <i>6</i> , <i>7</i> ).	
25-Feb-2005	1.4 Update temperature trip limits ( <i>Table 9</i> )	
06-May-2005	Update characteristics (Figure 3, 4, 28 and Table 6, 7).	
05-Aug-2005 2.0 Removed STM1403 references (Figure 1, 2, 3, 4, 5, 6, 7, 8, 26, 2 and Table 1, 2, 5, 6, 7, 9).		Removed STM1403 references (Figure 1, 2, 3, 4, 5, 6, 7, 8, 26, 27, 28 and Table 1, 2, 5, 6, 7, 9).
06-Jan-2006 Update status, characteristics, lead-free text, marking (Figure 4, Table 6, 7, 9).		Update status, characteristics, lead-free text, marking (Figure 4, 31 and Table 6, 7, 9).
08-Feb-2007 4.0 6		Update cover page, Figure 3: Block diagram, Table 7: Physical and environmental tamper detection levels, Figure 28: Temperature hysteresis, and part numbering (Table 9.)

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